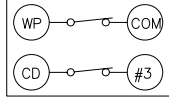
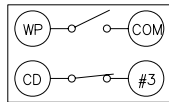
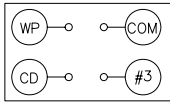


回路構成

CIRCUIT WITHOUT CARD

CARD INSERTED

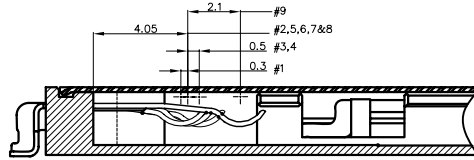
CARD INSERTED



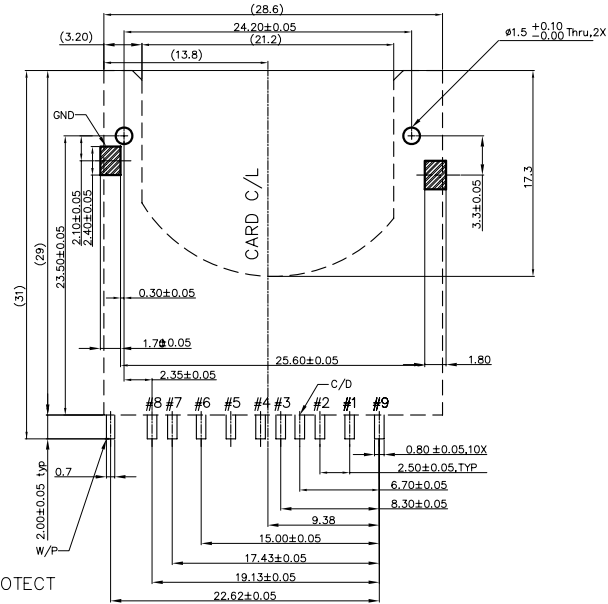
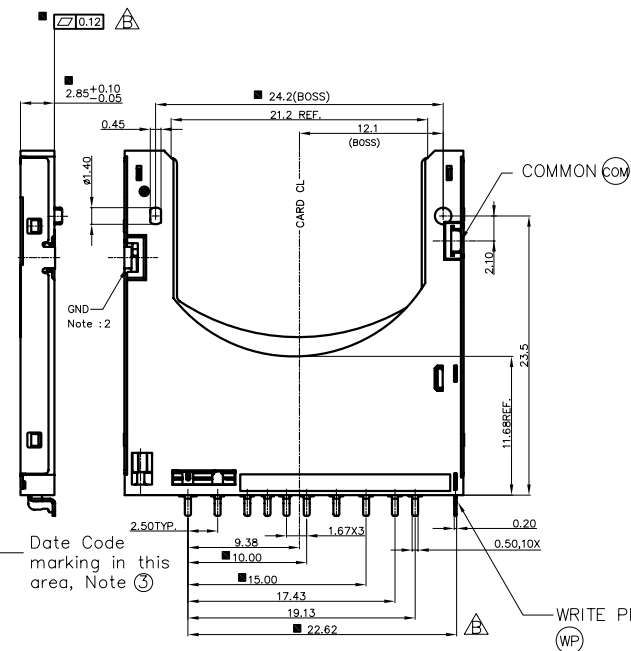
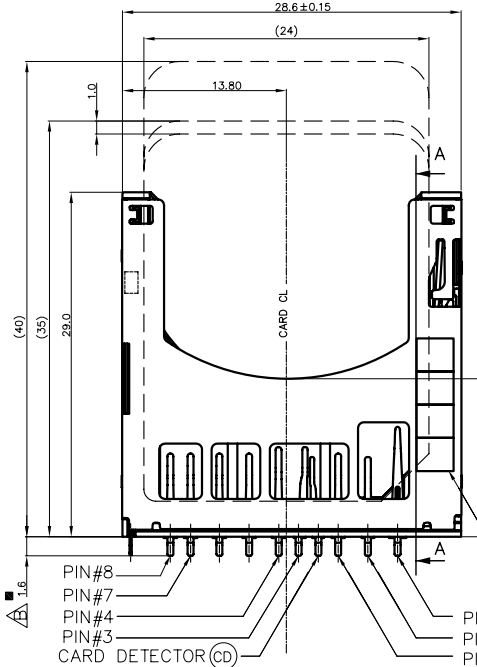
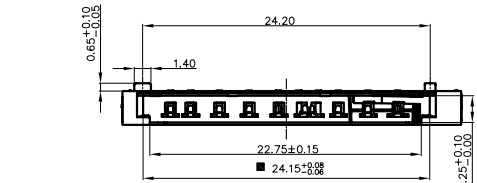
- WRITE PROTECT SW. : LOCK
- STATUS: READ ONLY
- WRITE PROTECT SW. : UNLOCK
- STATUS: WRITE ENABLE

SPECIFICATION	
Material	Insulator: LCP+30% G.F., UL 94V-0 rated,Color Black. Contact: Phosphor Bronze Shield Cover:stainless steel sheet metal,SUS304,0.2t.
Contact Plating	Contact Area: Gold Plating over1.27um(50u")min Ni underplate. Soldering Zone: 3.5um(120u")min sn/pb, 90/10alloy,over 1.27um(50u")min. Ni. undreplate.

Shield Cover: Gold flash in soldering zone over Nickel under plating overall.



SECTION A-A



Recommended P.C.B. Layout

UNLESS OTHERWISE SPECIFIED TOLERANCE	±0.3
AWG.	±0.2
0.	±0.1
.00	±0.05
.000	±0.05

Attend
ATTNED TECHNOLOGY INC.
TEL:886-2-26987028 FAX:886-2-26987078

SCALE: AS SHOWN	UNIT: mm
DRAWN Terry	2005/01/07
CHECKED	/ /
APPROVED	/ /

DRAWN NAME:	SD Socket Push Push Type Reverse Mount
PRODUCT NO.	104D-RAA-001
FILE NAME:	104D-RAA-001

REV.	DESCRIPTION	DATE	SIZE	REV.
			A4	